

CMOS 7-Bit Latch and Decoder Memory Interfaces

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#### Features

- Performs Memory Address Latch and Decoder Functions Multiplexed or Non-Multiplexed
- Interfaces Directly with the CDP1800-Series Microprocessors
- Allows Decoding for Systems Up to 32K Bytes

# **Ordering Information**

5V	10V	TEMP. RANGE	PACKAGE	PKG. NO.
CDP1883CE	CDP1883E	-40°C to +85°C	PDIP	E20.3

# Description

The CDP1883 is a CMOS 7-bit memory latch and decoder circuit intended for use in CDP1800-series microprocessor systems. It can serve as a direct interface between the multiplexed address bus of this system and up to four 8K x 8-bit memories to implement a 32K-byte memory system. With four 4K x 8-bit memories, a 16K-byte system can be decoded.

The device is also compatible with non-multiplexed address bus microprocessors. By connecting the clock input to  $V_{DD}$ , the latches are in the data-following mode and the decoded outputs can be used in general-purpose memory-system applications.

The CDP1833 is compatible with CDP1800-series microprocessors operating at maximum clock frequency.

The CDP1883 and CDP1883C are functionally identical. They differ in that the CDP1883 has a recommended operating voltage range of 4V to 10.5V and the C version has a recommended operating voltage range of 4V to 6.5V.

The CDP1883 and CDP1883C are supplied in 20 lead dual-in-line plastic packages (E Suffix).

#### **Pinout**

CDP1883, CDP1883C (PDIP) TOP VIEW





## **Absolute Maximum Ratings**

#### DC Supply Voltage Range, (V<sub>DD</sub>) (All Voltages Referenced to V<sub>SS</sub> Terminal) CDP1883 . . . . . -0.5V to +11V CDP1883C.....--0.5V to +7V Input Voltage Range, All Inputs . . . . . . . -0.5V to V<sub>DD</sub> +0.5V DC Input Current, Any One Input.....±10mA

## **Thermal Information**

Thermal Resistance (Typical)	$\theta_{JA}$ ( $^{o}C/W$ )
PDIP Package	80
Device Dissipation Per Output Transistor	
T <sub>A</sub> = Full Package Temperature Range	100mW
Operating Temperature Range (T <sub>A</sub> )	
Package Type E4	0°C to +85°C
Storage Temperature Range (T <sub>STG</sub> )65	<sup>o</sup> C to +150 <sup>o</sup> C
Lead Temperature (During Soldering)	
At distance $1/16 \pm 1/32$ In. $(1.59 \pm 0.79$ mm)	
from case for 10s max	+265 <sup>0</sup> C

CAUTION: Stresses above those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operation section of this specification is not implied.

**Recommended Operating Conditions** At T<sub>A</sub> = Full Package Temperature Range. For maximum reliability, operating conditions should be selected so that operation is always within the following ranges:

		CDP	1883	CDP1		
PARAMETER	SYMBOL	MIN	MAX	MIN	MAX	UNITS
DC Operating Voltage Range		4	10.5	4	6.5	V
Input Voltage Range		V <sub>SS</sub>	V <sub>DD</sub>	V <sub>SS</sub>	$V_{DD}$	V

# Static Electrical Specifications At $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $V_{DD} \pm 5\%$ , Except as Noted:

		C	ONDITION	18		CDP1883					
PARAMETER	SYMBOL	V <sub>O</sub> (V)	V <sub>IN</sub> (V)	V <sub>DD</sub> (V)	MIN	(NOTE 1) TYP	MAX	MIN	(NOTE 1) TYP	MAX	UNITS
Quiescent Device Current	I <sub>DD</sub>	-	0, 5	5	-	1	10	-	5	50	μΑ
Current		-	0, 10	10	-	10	100	-	-	-	μΑ
Output Low Drive	I <sub>OL</sub>	0.4	0, 5	5	1.6	3.2	-	1.6	3.2	-	mA
(Sink) Current		0.5	0, 10	10	3.2	6.4	-	-	-	-	mA
Output High Drive	Іон	4.6	0, 5	5	-1.15	-2.3	-	-1.15	-2.3	-	mA
(Source) Current		9.5	0, 10	10	-2.3	-4.6	-	-	-	i	mA
Output Voltage	V <sub>OL</sub>	-	0, 5	5	-	0	0.1	-	0	0.1	V
Low-Level (Note 2)		-	0, 10	10	-	0	0.1	-	-	-	V
Output Voltage	V <sub>OH</sub>	-	0, 5	5	4.9	5	-	4.9	5	i	V
High-Level (Note 2)		-	0, 10	10	9.9	10	-	-	-	-	V
Input Low Voltage	V <sub>IL</sub>	0.5, 4.5	-	5	-	-	1.5	-	-	1.5	V
		0.5, 9.5	-	10	-	-	3	-	-	-	V
Input High Voltage	V <sub>IH</sub>	0.5, 4.5	-	5	3.5	-	-	3.5	-	-	V
		0.5, 9.5	-	10	7	-	-	-	-	-	V
Input Leakage Current	I <sub>IN</sub>	Any	0, 5	5	-	-	±1	-	-	±1	μΑ
		Input	0, 10	10	-	-	±2	-	-	-	μΑ
Operating Current	I <sub>DD1</sub>	0, 5	0, 5	5	-	-	2	-	-	2	mA
(Note 3)		0, 10	0, 10	10	-	-	4	-	-	-	mA

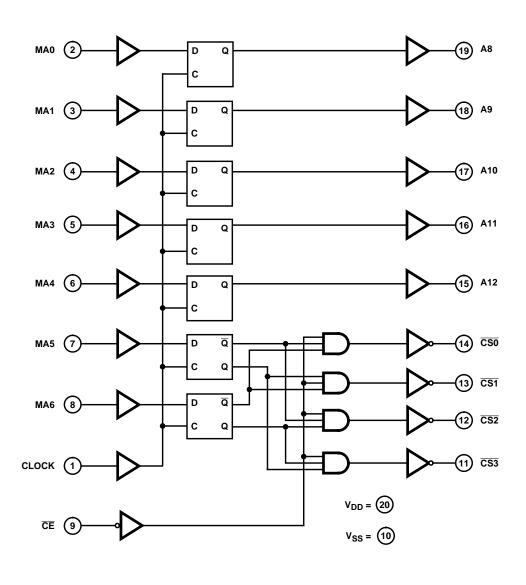
 $\textbf{Static Electrical Specifications} \quad \text{At T}_{A} = -40^{o}\text{C to } +85^{o}\text{C}, \ V_{DD} \pm 5\%, \ \text{Except as Noted: } \textbf{(Continued)}$ 

		CONDITIONS				CDP1883			CDP1883C			
PARAMETER	SYMBOL	ν <sub>ο</sub> (۷)	V <sub>IN</sub> (V)	V <sub>DD</sub> (V)	MIN	(NOTE 1) TYP	MAX	MIN	(NOTE 1) TYP	MAX	UNITS	
Minimum Data Retention Voltage	V <sub>DR</sub>	$V_{DD} = V_{DR}$			-	2	2.4	-	2	2.4	V	
Data Retention Current	I <sub>DR</sub>	\	V <sub>DD</sub> = 2.4V			0.01	1	-	0.5	5	μΑ	
Input Capacitance	C <sub>IN</sub>	-	-	-	-	5	7.5	-	5	7.5	pF	
Output Capacitance	C <sub>OUT</sub>	-	-	-	-	10	15	-	10	15	pF	

#### NOTES:

- 1. Typical values are for  $T_A = +25^{\circ}C$ .
- 2.  $I_{OL} = I_{OH} = \mu A$
- 3. Operating current measured at 200kHz for  $V_{DD}$  = 5V and 400kHz for  $V_{DD}$  = 10V, with outputs open circuit.

# Functional Diagram



# Signal Descriptions/Pin Functions

**CLOCK:** Latch Input Control - a high on the clock input will allow data to pass through the latch to the output pin. Data is latched on the high-to-low transition of the clock input. This pin is connected to TPA in CDP1800-series systems and tied to  $V_{DD}$  for other applications.

**MA0 - MA4:** Address inputs to the high-byte address latches.

**MA5 - MA6:** High byte address inputs decoded to produce chip selects  $\overline{CSO}$  -  $\overline{CS3}$ .

**CE:** CHIP ENABLE input - A low on this pin will enable the chip select decoder. A high on this pin forces  $\overline{CS0}$ ,  $\overline{CS1}$ ,  $\overline{CS2}$ , and  $\overline{CS3}$  outputs to a high (false) state.

A8 - A12: Latched high-byte address outputs.

**CS0** - **CS3**: One of four latched and decoded Chip Select outputs.

V<sub>DD</sub>, V<sub>SS</sub>: Power and ground pins, respectively.

#### **TRUTH TABLE**

	INP	UTS		OUTPUTS						
CE	CLK	MA5	MA6	CS0	CS1	CS2	CS3			
0	1	0	0	0	1	1	1			
0	1	1	0	1	0	1	1			
0	1	0	1	1	1	0	1			
0	1	1	1	1	1	1	0			
0	0	Х	Х	Previous State						
1	Х	Х	Х	1	1	1	1			

#### **TRUTH TABLE**

	INPUTS		OUTPUTS
CE	CLK	MA0 - 4	A8 - A12
Х	1	1	1
Х	1	0	0
Х	0	Х	Previous State

X = Don't Care

# Application Information

The CDP1883 and CDP1883C can be interfaced, without external components, with CDP1800-series microprocessor systems. These microprocessors feature a multiplexed address bus and provide an address latch signal (TPA) that is used as the clock input of the CDP1883. See Figure 2 and Figure 3.

This signal is used to latch 7 bits of the high-order address. The lower five high-order address inputs are latched and held to be used with the eight lower-order address inputs to access an 8K  $\times$  8-bit memory. The two upper high-order address inputs are latched and decoded for use as chip selects.

The latched address and decoding functions of the CDP1883 and CDP1883C allow them to operate with 32K-byte memory systems. In addition, smaller memory systems can be configured with 4K x 8-bit or smaller memories, or a mix of memory sizes up to 8K x 8-bit.

**Dynamic Electrical Specifications**  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{DD} \pm 5\%$ ,  $t_R$ ,  $t_F = 20\text{ns}$ ,  $V_{IH} = 0.7$   $V_{DD}$ ,  $V_{IL} = 0.3$   $V_{DD}$ ,  $C_L = 100\text{pF}$ . See Figure 1

				CDP1883	3	CDP1883C			
PARAMETER		V <sub>DD</sub> (V)	MIN	(NOTE 1) TYP	(NOTE 2) MAX	MIN	(NOTE 1) TYP	(NOTE 2) MAX	UNITS
Minimum Setup Time,	<sup>t</sup> MACL	5	-	10	35	-	10	35	ns
Memory Address to CLOCK		10	-	8	25	-	-	-	ns
Minimum Hold Time,	<sup>t</sup> CLMA	5	-	8	25	-	8	25	ns
Memory Address After CLOCK		10	-	8	25	-	-	-	ns
Minimum CLOCK Pulse Width	<sup>t</sup> CLCL	5	-	50	75	-	50	75	ns
		10	-	25	40	-	-	-	ns
PROPAGATION DELAY TIMES									
Chip Enable to Chip Select	tCECS	5	-	75	150	-	75	150	ns
		10	-	45	100	-	-	-	ns
CLOCK to Chip Select	t <sub>CLCS</sub>	5	-	100	175	-	100	175	ns
		10	-	65	125	-	-	-	ns

**Dynamic Electrical Specifications**  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{DD} \pm 5\%$ ,  $t_R$ ,  $t_F = 20\text{ns}$ ,  $V_{IH} = 0.7$   $V_{DD}$ ,  $V_{IL} = 0.3$   $V_{DD}$ ,  $C_L = 100\text{pF}$ . See Figure 1 **(Continued)** 

				CDP1883	3				
PARAMETER		V <sub>DD</sub> (V)	MIN	(NOTE 1) TYP	(NOTE 2) MAX	MIN	(NOTE 1) TYP	(NOTE 2) MAX	UNITS
CLOCK to Address	t <sub>CLA</sub>	5	-	100	175	-	100	175	ns
		10	-	65	125	-	-	-	ns
Memory Address to Chip Select	t <sub>MACS</sub>	5	-	100	175	-	100	175	ns
		10	-	75	125	-	-	-	ns
Memory Address to Address	t <sub>MAA</sub>	5	-	80	125	-	80	125	ns
		10	-	40	60	-	-	-	ns

#### NOTES:

- 1. Typical values are for  $T_A = 25^{\circ}C$ .
- 2. Maximum limits of minimum characteristics are the values above which all devices function.

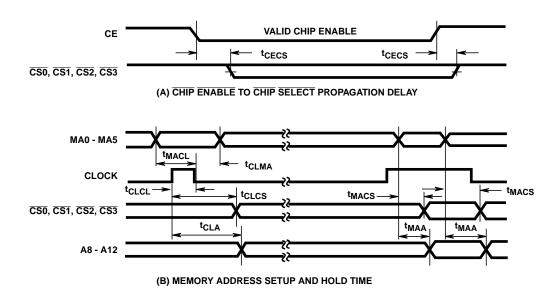


FIGURE 1. CDP1883 TIMING WAVEFORMS

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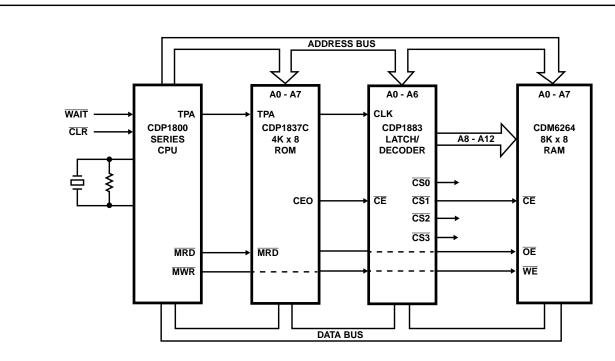


FIGURE 2. MINIMUM CDP1800-SYSTEM USING THE CDP1883 INTERFACE WITH AN 8K X 8-BIT MEMORY

